

Travel Subsidy Application Form

***Ethical Guidance for Research and Application of
Pervasive and Autonomous Information Technology (PAIT)
March 3-4, 2010***

<http://poynter.indiana.edu/pait/>

Please read the Travel Subsidy Policy before completing this form. This form can be filled out on the screen and then printed, or printed and then filled out by hand (please print neatly!) or typewriter.

Name: _____

I qualify for the travel subsidy because [check all that apply]

- | | |
|---|---|
| <input type="checkbox"/> I am a woman | <input type="checkbox"/> I am a Pacific Islander |
| <input type="checkbox"/> I am an African American | <input type="checkbox"/> I am a disabled person |
| <input type="checkbox"/> I am a Latino or Latina | <input type="checkbox"/> I am a current graduate student |
| <input type="checkbox"/> I am a Native American | <input type="checkbox"/> I received my terminal degree after July 1, 2008 |

I live [check one]

- within 250 miles of Cincinnati
- 250-500 miles from of Cincinnati
- over 500 miles from Cincinnati

I estimate the cost of my travel, lodging, and per diem to be \$_____. (Note: this figure is not binding and will not be used in judging applications; it will help the Planning Committee better estimate how many subsidies can be awarded **after** applicants have been ranked)

- I have enclosed a completed registration form and sent a statement of contribution for the PAIT workshop via e-mail to [Glenda Murray](#).
- I have enclosed a copy of my CV.
- I understand that my expenses will not be reimbursed unless my original receipts are received at the Poynter Center by April 2, 2010, and that my reimbursement is limited to the amount indicated in the PAIT Travel Subsidy Policy.

Signature: _____

Please submit all application materials as directed on the registration form.

Please note that the completed Travel Subsidy Form with your signature must be sent via regular mail or FAX, but may be sent first via e-mail to speed processing.

To be considered for a travel subsidy, all application materials must be received on or before **September 28, 2009**.